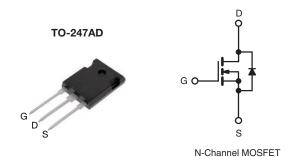
Vishay Siliconix

HALOGEN FREE

E Series Power MOSFET

PRODUCT SUMMARY				
V _{DS} (V) at T _J max.	650			
R _{DS(on)} max. at 25 °C (Ω)	$V_{GS} = 10 \text{ V}$	0.125		
Q _g max. (nC)	130			
Q _{gs} (nC)	15			
Q _{gd} (nC)	39			
Configuration	Single			



FEATURES

- Low figure-of-merit (FOM) Ron x Qa
- Low input capacitance (Ciss)
- · Reduced switching and conduction losses
- Ultra low gate charge (Q_a)
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

APPLICATIONS

- Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
 - High-intensity discharge (HID)
 - Fluorescent ballast lighting
 - LED lighting
- Industrial
 - Welding
 - Induction heating
 - Motor drives
- · Battery chargers
- Renewable energy
 - Solar (PV inverters)

ORDERING INFORMATION	
Package	TO-247AD
Lead (Pb)-free and Halogen-free	SiHW30N60E-GE3

ABSOLUTE MAXIMUM RATINGS (T _C	= 25 °C, unles	s otherwis	se noted)		
PARAMETER			SYMBOL	LIMIT	UNIT
Drain-Source Voltage			V_{DS}	600	
Gate-Source Voltage			V _{GS}	± 20	V
Gate-Source Voltage AC (f > 1 Hz)				30	
Continuous Drain Current (T _J = 150 °C)	V _{GS} at 10 V	T _C = 25 °C	- I _D	29	
	V _{GS} at 10 V	T _C = 100 °C		18	Α
Pulsed Drain Current ^a			I _{DM}	65	
Linear Derating Factor				2	W/°C
Single Pulse Avalanche Energy ^b			E _{AS}	690	mJ
Maximum Power Dissipation			P_{D}	250	W
Operating Junction and Storage Temperature Range			T _J , T _{stg}	-55 to +150	°C
Drain-Source Voltage Slope	$V_{DS} = 0 \text{ V to } 8$	80 % V _{DS}	70		V/ns
Reverse Diode dV/dt ^d			dV/dt	18	V/fis
Soldering Recommendations (Peak Temperature)c	for 10 s			300	°C

Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature.
- b. V_{DD} = 50 V, starting T_J = 25 °C, L = 28.2 mH, R_q = 25 Ω , I_{AS} = 7 A.
- c. 1.6 mm from case.
- d. $I_{SD} \le I_D$, dI/dt = 100 A/ μ s, starting $T_J = 25$ °C.



Vishay Siliconix

THERMAL RESISTANCE RATINGS					
PARAMETER	SYMBOL	TYP.	MAX.	UNIT	
Maximum Junction-to-Ambient	R _{thJA}	-	62	°C/W	
Maximum Junction-to-Case (Drain)	R_{thJC}	-	0.5	G/ VV	

PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
Static		-			•	•	
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$		600	-	-	V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference	e to 25 °C, I _D = 250 μA	-	0.64	-	V/°C
Gate-Source Threshold Voltage (N)	V _{GS(th)}	V _{DS} =	V _{DS} = V _{GS} , I _D = 250 μA		2.8	4.0	V
Gate-Source Leakage	I _{GSS}		V _{GS} = ± 20 V	-	-	± 100	nA
Zero Gate Voltage Drain Current	I _{DSS}		= 600 V, V _{GS} = 0 V /, V _{GS} = 0 V, T _J = 150 °C	-	-	1 100	μA
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} = 10 V		-	0.104	0.125	Ω
Forward Transconductancea	9 _{fs}		$_{\rm S} = 8 \text{ V}, I_{\rm D} = 3 \text{ A}$	-	5.4	-	S
Dynamic			-	l	1		
Input Capacitance	C _{iss}	$V_{GS} = 0 V$,		-	2600	-	pF
Output Capacitance	C _{oss}		$V_{GS} = 0 V$, $V_{DS} = 100 V$,		138	-	
Reverse Transfer Capacitance	C _{rss}	f = 1.0 MHz		-	3	-	
Effective Output Capacitance, Energy Related ^b	C _{o(er)}	V _{DS} = 0 V to 480 V, V _{GS} = 0 V		-	98	-	
Effective Output Capacitance, Time Related ^c	C _{o(tr)}			-	346	-	
Total Gate Charge	Qq			-	85	130	
Gate-Source Charge	Q _{gs}	V _{GS} = 10 V	$V_{GS} = 10 \text{ V}$ $I_D = 15 \text{ A}, V_{DS} = 480 \text{ V}$		15	-	nC
Gate-Drain Charge	Q _{gd}				39	-	
Turn-On Delay Time	t _{d(on)}			-	19	40	
Rise Time	t _r	$V_{DD} = 380 \text{ V}, I_{D} = 15 \text{ A}, V_{GS} = 10 \text{ V}, R_{g} = 4.7 \Omega$		-	32	65	ns ns
Turn-Off Delay Time	t _{d(off)}			-	63	95	
Fall Time	t _f			-	36	75	
Gate Input Resistance	R_{g}	f = 1 MHz, open drain		-	0.63	-	Ω
Drain-Source Body Diode Characteristic	s						
Continuous Source-Drain Diode Current	I_S	MOSFET symbol showing the integral reverse p - n junction diode		-	-	29	
Pulsed Diode Forward Current	I _{SM}			-	-	65	А
Diode Forward Voltage	V _{SD}	$T_J = 25 ^{\circ}\text{C}, I_S = 15 \text{A}, V_{GS} = 0 \text{V}$		-	-	1.3	V
Body Diode Reverse Recovery Time	t _{rr}			_	402	605	ns
Body Diode Reverse Recovery Charge	Q _{rr}	$T_J = 25 ^{\circ}\text{C}, I_F = I_S = 15 \text{A},$ $dI/dt = 100 \text{A/}\mu\text{s}, V_R = 20 \text{V}$		-	7	15	μC
Reverse Recovery Current	I _{RRM}			_	32	65	Α

Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature.
- b. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} .
- c. $C_{oss(tr)}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} .



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

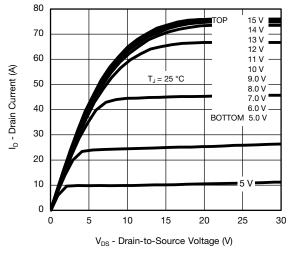


Fig. 1 - Typical Output Characteristics, T_C = 25 °C

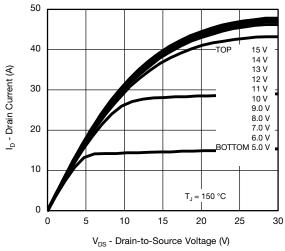


Fig. 2 - Typical Output Characteristics, T_C = 150 °C

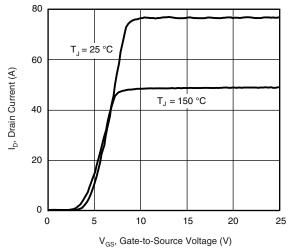


Fig. 3 - Typical Transfer Characteristics

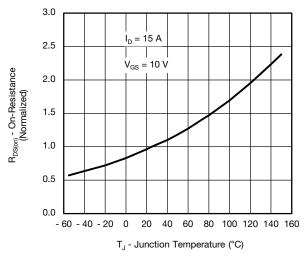


Fig. 4 - Normalized On-Resistance vs. Temperature

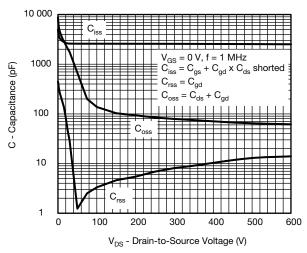


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

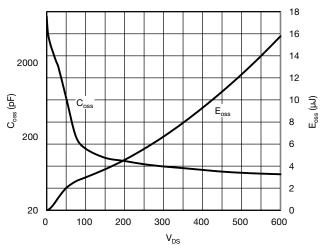


Fig. 6 - C_{oss} and E_{oss} vs. V_{DS}



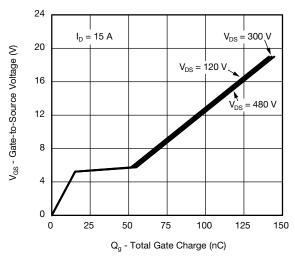


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

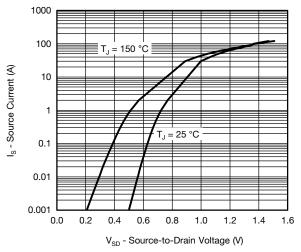


Fig. 8 - Typical Source-Drain Diode Forward Voltage

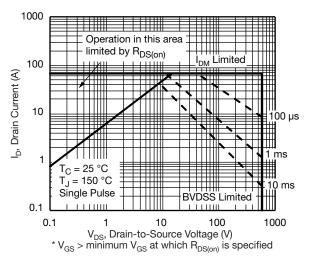


Fig. 9 - Maximum Safe Operating Area

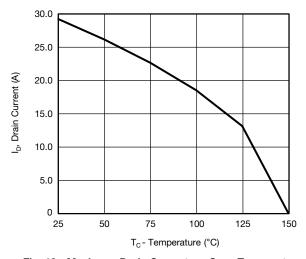


Fig. 10 - Maximum Drain Current vs. Case Temperature

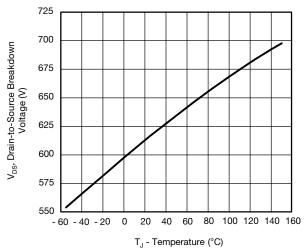
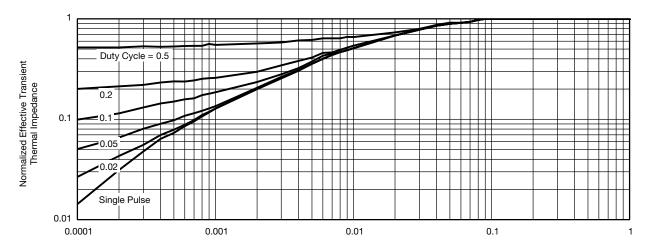
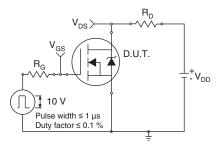


Fig. 11 - Temperature vs. Drain-to-Source Voltage





Square Wave Pulse Duration (s)
Fig. 12 - Normalized Thermal Transient Impedance, Junction-to-Case



www.vishay.com

Fig. 13 - Switching Time Test Circuit

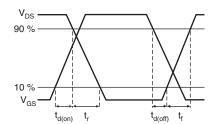


Fig. 14 - Switching Time Waveforms

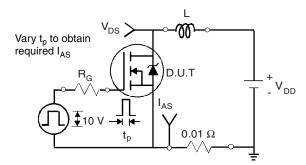


Fig. 15 - Unclamped Inductive Test Circuit

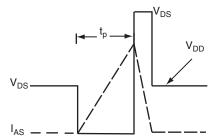


Fig. 16 - Unclamped Inductive Waveforms

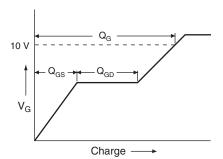


Fig. 17 - Basic Gate Charge Waveform

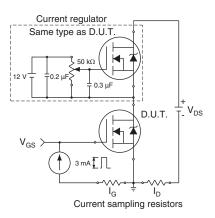
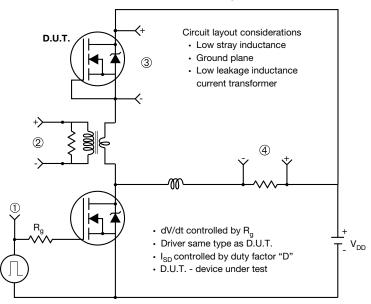


Fig. 18 - Gate Charge Test Circuit



Peak Diode Recovery dV/dt Test Circuit



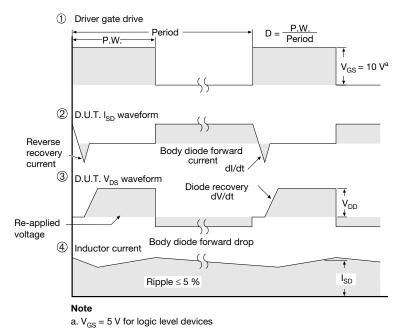
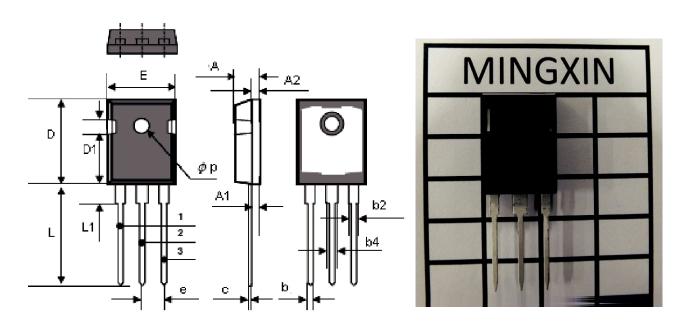


Fig. 19 - For N-Channel

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Vishay Siliconix

TO-247AD (HIGH VOLTAGE)



MILLIMETERS INCHES DIM. MIN. MAX. MIN. MAX. 5.10 0.193 0.200 4.90 A1 2.30 2.40 0.090 0.094 A2 1.92 2.08 0.076 0.082 b 1.15 1.25 0.045 0.049 b2 1.95 2.05 0.077 0.081 b4 2.85 3.11 0.112 0.122 0.6 BSC 0.024 BSC С D 20.80 21.46 0.819 0.845 D1 4.37 4.63 0.172 0.182 5.32 5.58 0.209 0.220 е Ε 15.77 16.03 0.621 0.631 L 19.85 20.11 0.781 0.792 L1 4.07 4.33 0.160 0.170 3.66 0.140 0.144 3.56

ECN: X12-0191-Rev. A, 22-Oct-12

DWG: 6010

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